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**Application Information**

Title : STRUCTURE AND METHOD FOR TRANSVERSE FIELD  
ENHANCEMENT  
Total Drawing Sheets : 13  
Formal Drawings : YES  
Application Type : Utility  
Attorney Docket Number : 500990.03 (30013/US/2)  
Assigned : Yes (Large Entity)

**Representative Information**

Representative Customer No. : 27,076

### Continuity Information

This application is a	:	divisional of
>Application One	:	10/251,340
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which is a	:	divisional of
>>Application Two	:	09/916,563
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